

Thermal paste

Paste 8702 (ex PA 20)

- silicone- and solvent-free heat-conducting paste
- 1 component
- CMR-free *
- high-performance and electrically insulating
- · excellent thermal conductivity
- no metallic fillers
- · high-long-term stability
- · good creeping properties
- ideal for different cooling applications, improves the heat-transfer

Product specification:

Туре:	Non-curing and non-drying p	aste	
Viscosity (23 °C):	Paste 8702	150'000 - 200'000 mPa·s	
Density (22 °C):	Paste 8702	2.20 - 2.50 g/cm³	
Colour:	Nature (cream)		
Shelf life:	12 months in sealed original (15°C to 25°C).	12 months in sealed original containers when stored in dry conditions (15°C to 25°C).	

^{*} not subject to CMR labelling according to section 2 of the safety data sheet



Physical properties:

Thermal conductivity:	2.0 - 2.3 W/(m·K) (22 °C) 2.0 - 2.3 W/(m·K) (60 °C optional)	DIN EN ISO 22007
Thermal resistance:	No blooming after 4 h at 200 °C	
Operating temperature:	-60 °C up to +200 °C	

Electrical properties:

Dielectric strength:	25 kV/mm	IEC 60243-1, VDE 0303, Tl.2
Volume resistance:	10 ¹⁶ Ω·cm (23 °C/ 50 % r.F.)	IEC 60243-1, VDE0303, TI.30

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